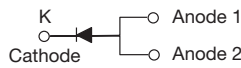


High Current Density Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier

 Ultra Low $V_F = 0.39$ V at $I_F = 5$ A

 eSMP[®] Series


SMPC (TO-277A)


DESIGN SUPPORT TOOLS
[click logo to get started](#)
3D
Models
Available

| PRIMARY CHARACTERISTICS | |
|-------------------------------------------|----------------|
| $I_{F(AV)}$ | 10.0 A |
| V_{RRM} | 60 V |
| I_{FSM} | 180 A |
| V_F at $I_F = 10.0$ A ($T_A = 125$ °C) | 0.52 V |
| T_J max. | 175 °C |
| Package | SMPC (TO-277A) |
| Circuit configuration | Single |

FEATURES

- Very low profile - typical height of 1.1 mm
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

 AUTOMOTIVE
GRADE
Available

RoHS
COMPLIANT
HALOGEN
FREE
TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA
Case: SMPC (TO-277A)

 Molding compound meets UL 94 V-0 flammability rating
 Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

| MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted) | | | |
|-----------------------------------------------------------------------------------|-------------|-------------|------|
| PARAMETER | SYMBOL | V10PM6 | UNIT |
| Device marking code | | V10M6 | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 60 | V |
| Maximum average forward rectified current (fig. 1) | $I_F^{(1)}$ | 10.0 | A |
| | $I_F^{(2)}$ | 4.6 | |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I_{FSM} | 180 | A |
| Operating junction temperature range | $T_J^{(3)}$ | -40 to +175 | °C |
| Storage temperature range | T_{STG} | -55 to +175 | °C |

Notes

(1) Mounted on 30 mm x 30 mm pad areas aluminum PCB

(2) Free air, mounted on recommended copper pad area

 (3) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|----------------------------------------------------------------------------|-------------------------|-------------------------|-------------------------------|------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | I _F = 5.0 A | T _A = 25 °C | V _F ⁽¹⁾ | 0.50 | - | V |
| | I _F = 10.0 A | | | 0.58 | 0.64 | |
| | I _F = 5.0 A | T _A = 125 °C | | 0.39 | - | |
| | I _F = 10.0 A | | | 0.52 | 0.60 | |
| Reverse current | V _R = 60 V | T _A = 25 °C | I _R ⁽²⁾ | - | 0.8 | mA |
| | | T _A = 125 °C | | 5.0 | 20 | |
| Typical junction capacitance | 4.0 V, 1 MHz | | C _J | 1650 | - | pF |

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: pulse width ≤ 5 ms

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | |
|-------------------------------------------------------------------------|------------------------------------|--------|------|
| PARAMETER | SYMBOL | V10PM6 | UNIT |
| Typical thermal resistance | R _{θJA} ⁽¹⁾⁽²⁾ | 75 | °C/W |
| | R _{θJM} ⁽³⁾ | 4 | |

Notes

- (1) The heat generated must be less than the thermal conductivity from junction to ambient: dP_D/dT_J < 1/R_{θJA}
(2) Free air mounted on recommended copper pad area; thermal resistance R_{θJA} - junction to ambient
(3) Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance R_{θJM} - junction to mount

| ORDERING INFORMATION (Example) | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| V10PM6-M3/H | 0.10 | H | 1500 | 7" diameter plastic tape and reel |
| V10PM6-M3/I | 0.10 | I | 6500 | 13" diameter plastic tape and reel |
| V10PM6HM3/H ⁽¹⁾ | 0.10 | H | 1500 | 7" diameter plastic tape and reel |
| V10PM6HM3/I ⁽¹⁾ | 0.10 | I | 6500 | 13" diameter plastic tape and reel |

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

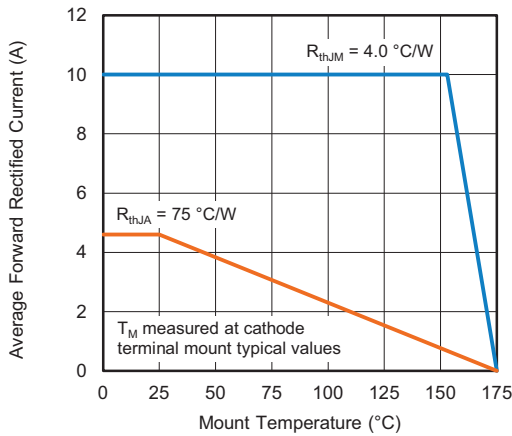


Fig. 1 - Forward Current Derating Curve

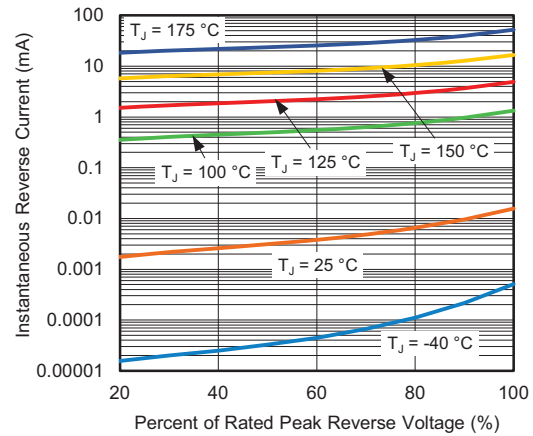


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

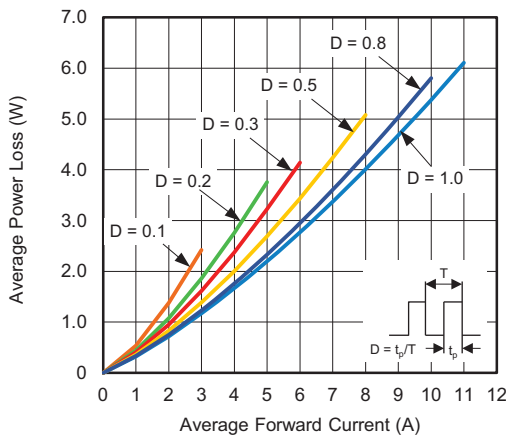


Fig. 2 - Forward Power Loss Characteristics

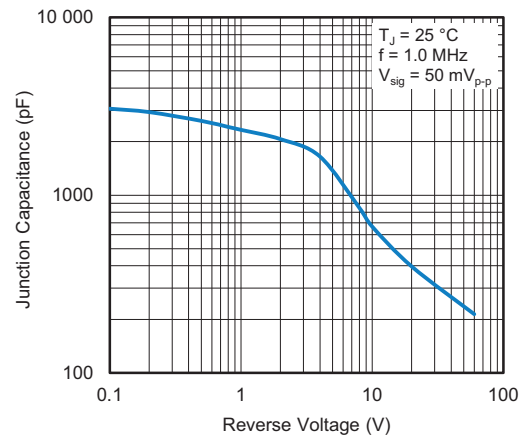


Fig. 5 - Typical Junction Capacitance

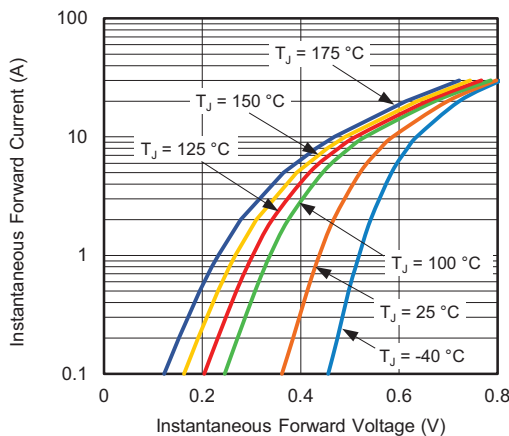


Fig. 3 - Typical Instantaneous Forward Characteristics

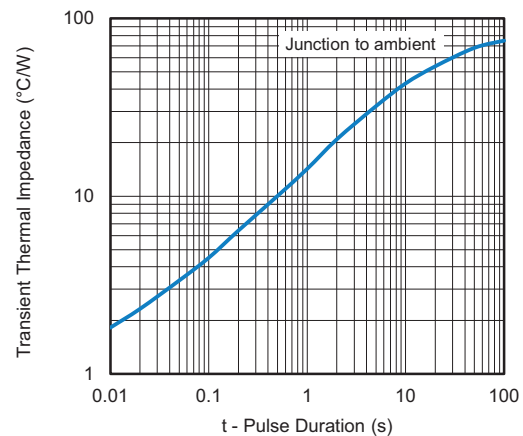
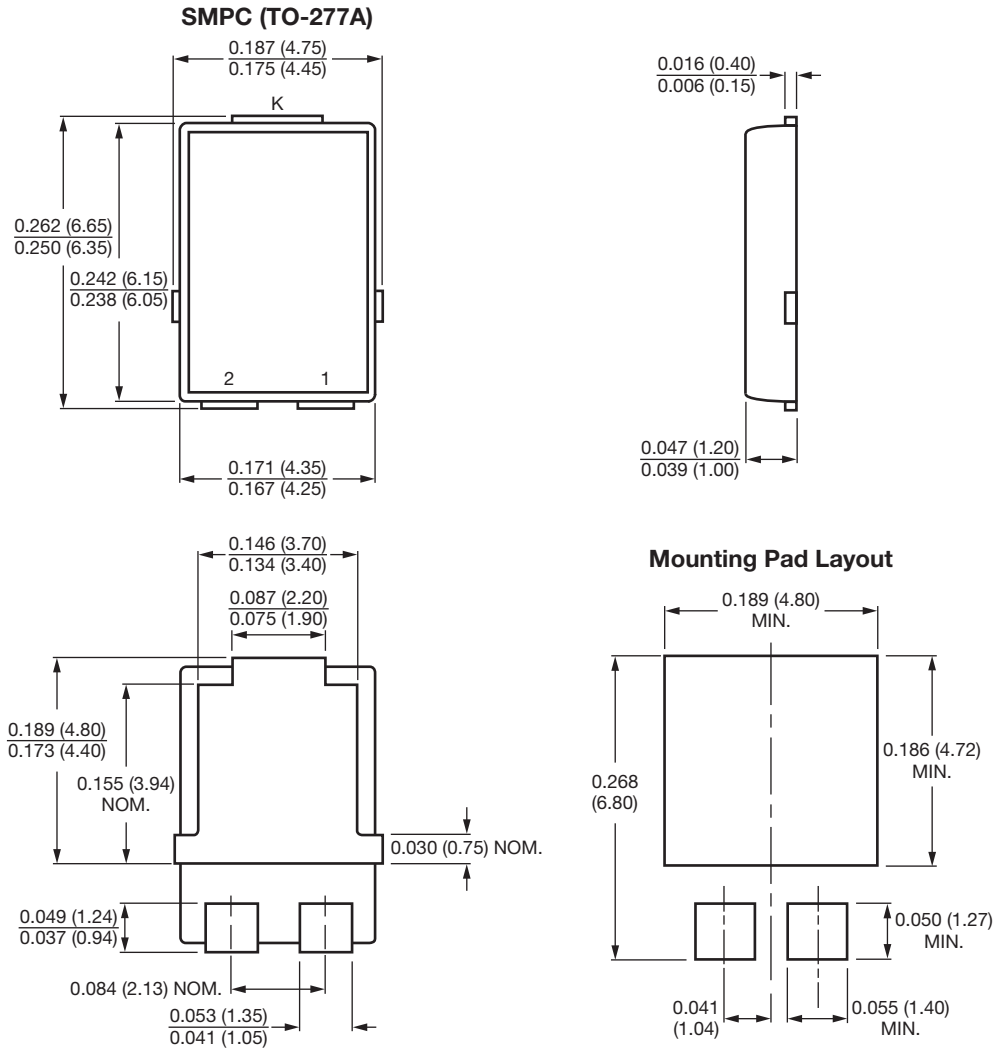


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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